General Description

The AS9632 is a 2-Vrms cap-less stereo line driver. The device is ideal for single supply electronics. Cap-less design can eliminate output dc-blocking capacitors for better low frequency response and save cost. The AS9632 is capable of delivering 2-Vrms output into a 10kΩ load with 3.3V supply. The gain settings can be set by users from ±1V/V to ±10V/V externally, and gain can be configured individually for R/L channel. The AS9632 has built-in active-mute control for pop-less audio on/off control. The AS9632 has internal and external under voltage protection to prevent POP noise. Built-in de-pop control sequence also help AS9632 to be a pop-less device.

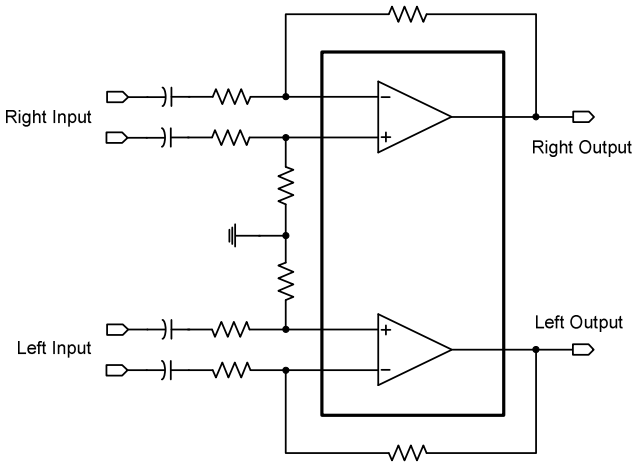
Applications

- LCD / PDP TVs
- DVD players
- Set-Top Boxes
- Home Theater in Box

Features

- Operation Voltage: 3.0V to 3.6V
- Cap-less Output
  - Eliminates Output Capacitors
  - Improves Low Frequency Response
  - Reduces POP/Clicks
  - Reduce Board Area and Component Cost
- Low Noise and THD
  - SNR > 102dB
  - Typical Vn < 12uVrms
  - THD+N < 0.02% at 20Hz~20kHz
- Maximum Output Voltage Swing into 10kΩ Load
  - 2Vrms at 3.3V Supply Voltage
- 600Ω Output Load Compliant
- Differential Input, single-Ended Output
- External Gain Setting from 1V/V to 10V/V
- Fast Start-up Time : 0.5ms
- Integrated De-Pop Control
- External Under Voltage Protection
- Thermal Protection
- Active Mute Control for Pop-less Audio ON/OFF Control
- +/-8kV IEC ESD Protection at line outputs
- TSSOP-14

Typical Application



Order Information

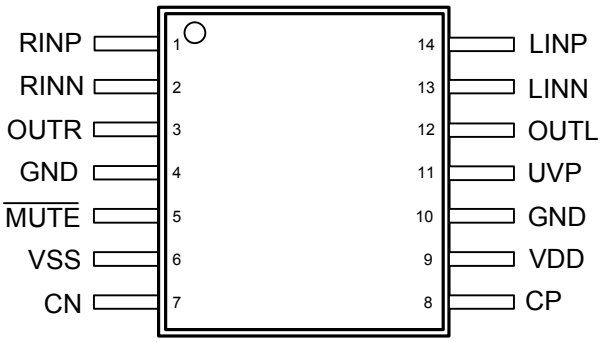
Part Number	Package	Packing	Remark
AS9632DT/TR-HF	TSSOP-14	Tape &Reel MPQ=2.5k	Green

Pin Description

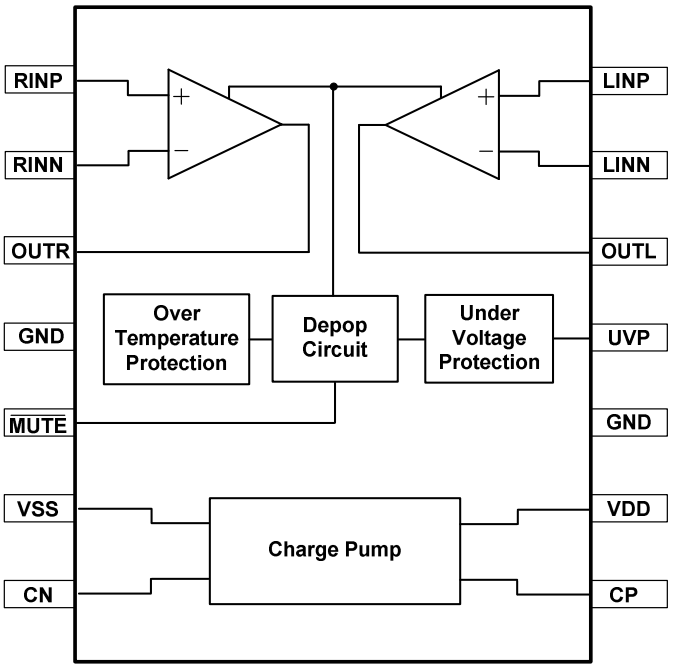
Pin#	Name	Type (1)	Description
1	LINP	I	Left channel OP positive input
2	LINN	I	Left channel OP negative input
3	OUTL	O	Left channel OP output
4	SGND	P	Signal ground
5	$\overline{\text{MUTE}}$	I	Mute, active low
6	PVSS	O	Supply voltage
7	CN	I/O	Charge-pump flying capacitor negative terminal
8	CP	I/O	Charge-pump flying capacitor positive terminal
9	PVDD	P	Positive supply
10	PGND	P	Power ground
11	UVP	I	Under-voltage protection input
12	OUTR	O	Right channel OP output
13	RINN	I	Right channel OP negative input
14	RINP	I	Right channel OP positive input

(1) I=input, O=output, P=power

TSSOP-14
(Top View)



Functional Block Diagram



Available Package

Part Number	Package	θ_{ja} (℃/W)(1)	θ_{jc} (℃/W)(2)
AS9632DT/TR-HF	TSSOP-14	100	32

(1) θja is measured at room temperature (TA=25℃), natural convection environment test board, which is constructed with a thermal efficient, 2-layers PCB. The measurement is tested using the JEDEC51-3 thermal measurement standard.

(2) θjc represents the heat resistance for the heat flow between the chip and package's top surface.

Marking Information.

AS9632
Line 1 : LOGO
Line 2 : Product No.
Line 3 : Date Code

Absolute Maximum Ratings (1)

Symbol	Parameter	Value	Unit
	Supply Voltage, VDD to GND	-0.3 to 5.5	V
V_I	Input Voltage	VSS -0.3 to VDD+0.3	V
R_L	Minimum load impedance	> 600	Ω
	$\overline{MUTE}$ to GND	-0.3 to VDD+0.3	V
T_{stg}	Storage temperature range	-65 to 150	°C
T_J	Maximum junction temperature	125	°C

(1) The absolute maximum ratings are limiting values of operation, safety of the device cannot be guaranteed if beyond those values.

Recommended Operating Conditions

Symbol	Parameter		Min	Nom	Max	Unit
V_{DD}	Supply Voltage		3.0	3.3	3.6	V
V_{IH}	High Level Input Voltage	$\overline{MUTE}$		60		% of V_{DD}
V_{IL}	Low Level Input Voltage	$\overline{MUTE}$		40		% of V_{DD}
T_A	Operating Ambient Temperature Range		0		70	°C
T_J	Operation junction temperature range		-40		125	°C
R_L	Load Resistance		600			Ω

Electrical Characteristics

PVDD=3.3V, T_A=25℃, RL=10kΩ, C_{FLY}=C_{PVSS}=1μF, C_{IN}=1μF, R_I=10kΩ, R_F=20kΩ (unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Nom	Max	Unit
I_{DD}	V_{DD} Supply Current	$\overline{MUTE}$=VDD		7	15	mA
I_{SD}	V_{DD} Shutdown Current	$\overline{MUTE}$=0V			100	μA
Ii	Input Current	$\overline{MUTE}$ pin		0.1		μA
V_O	Output Voltage (Outputs In Phase)	THD+N=1%, V_{DD}=3.3V, fIN=1kHz		2.3		Vrms
THD+N	Total Harmonic Distortion Plus Noise	V_O=2Vrms, f_{IN}=1kHz		0.002		%
Crosstalk	Channel Separation	V_O=2Vrms, f_{IN}=1kHz		-110		dB
V_N	Output Noise	R_I=10k, R_F=10k		11	15	μVrms
V_{SR}	Slew Rate			8		V/μs
SNR	Signal to Noise Ratio	V_O=2Vrms, R_I=10k, R_F=10k, A-weighted	102	107		dB
G_{BW}	Unit-Gain Bandwidth			8		MHz
A_{VO}	Open-Loop Gain		80			dB
V_{OS}	Output Offset Voltage	V_{DD}=3.0V to 3.6V, Input Grounded	-5		5	mV

Electrical Characteristics (Con't)

PVDD=3.3V, T_A=25℃, R_L=10kΩ , C_{FLY}=C_{PVSS}=1μF, C_{IN}=1μF, R_I=10kΩ , R_F=20kΩ (unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Nom)	Max	Unit
PSRR	Power Supply Rejection Ratio	V_{DD}=3.0V to 3.6V, Vrr=200mVrms, f_{IN}=1kHz		-80	-60	dB
R_I	Input Resistor Range		1	10	47	kΩ
R_F	Feedback Resistor Range		4.7	20	100	kΩ
f_{CP}	Charge-Pump Frequency		400	500	600	kHz
	Maximum capacitive Load			220		pF
V_{UVP}	External Under Voltage Detection			1.25		V
I_{HYS}	External Under Voltage Detection Hysteresis Current			5		μA
TSD	Over Temperature Protection Level			150		°C
$T_{start-up}$	Start-up Time			0.5		ms

Application Information

Line Driver Amplifiers Operation

A conventional inverting line-driver amplifier always requires an output dc-blocking capacitor and a bypass capacitor, see Figure 1. DC blocking capacitors are large in size and cost a lot. It also restricts the output low frequency response. POP will occur if the charge and discharge processes on output capacitors are not carefully take cared. Besides, it needs to wait for a long time to charge VOUT from 0V to VDD/2.

For a cap-less line driver, see figure 2, a negative supply voltage (-VDD) is produced by the integrated chargepump, and feeds to line driver's negative supply instead of ground. The positive input can directly connect to ground without a C_{BYPASS}, and VOUT is biased at ground which can eliminate the output dcblocking capacitors. The output voltage swing is doubled compared to conventional amplifiers.

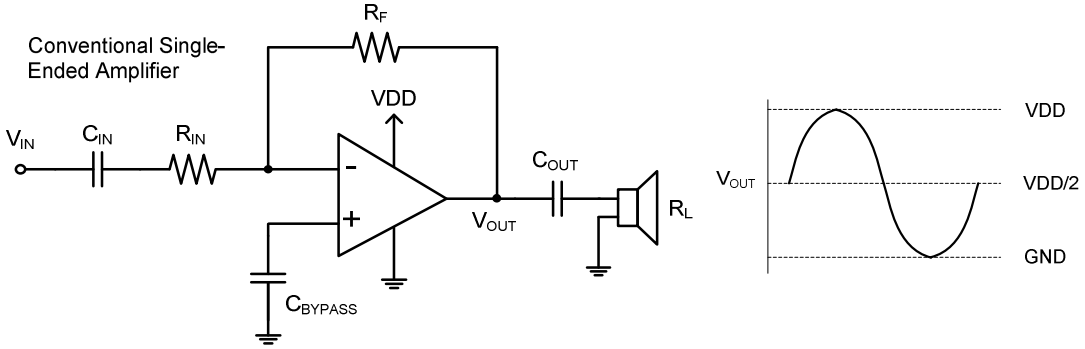


Figure 1. Conventional Line Driver Amplifier

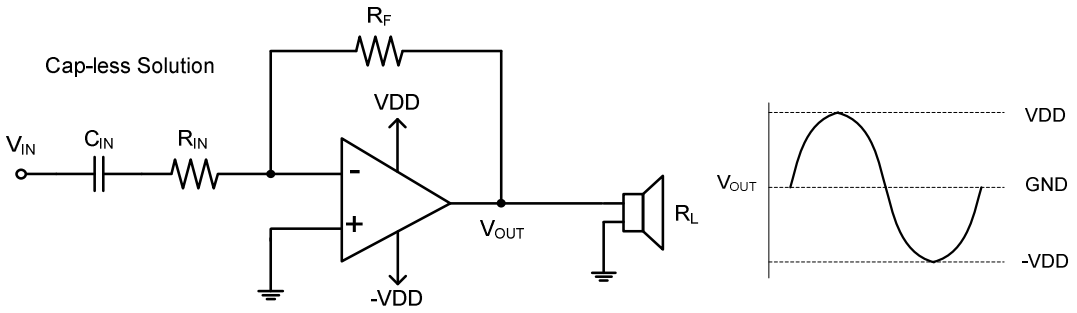


Figure 2. Cap-less Line Driver Amplifier

External Under-Voltage Protection

The external under-voltage protection is used to mute the line-driver before any input voltage change to generate a POP. The threshold of UVP pin is designed to 1.25V. By using a resistor divider, users can decide the UVP level and hysteresis level. The levels can be obtained by following equations:

$$V_{UVP} = (1.25V - 6\mu A \times R13) \times (R11 + R12) / R12$$
$$Hysteresis = 5\mu A \times R13 \times (R11 + R12) / R12$$

With the condition R13 >> (R11 // R12). For example, to obtain V_{UVP}=2.67V, Hysteresis=0.37V, R11=1.5kΩ, R12=1kΩ, R13=30kΩ.

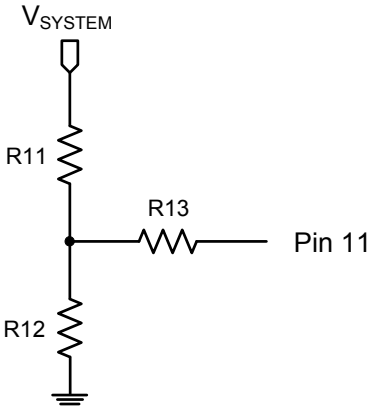


Figure 3. Application Circuit of UVP Pin

Charge-Pump Operation

The charge-pump is used to generate a negative supply voltage to supply to line-driver. It needs two external capacitors, C_{FLY} and C_{PVSS}, for normal operation, see figure 4 (a). The operation can be analyzed with two phase. In phase I, see figure 4 (b), C_{FLY} is charged to PVDD, and in phase II, see figure 4 (c), the charges on CFLY are shared with CPVSS, that makes PVSS a negative voltage. After an adequate clock cycles, PVSS will be equaled to –PVDD. Low ESR capacitors are recommended, and the typical value of C_{FLY} and C_{PVSS} is 1F. A smaller capacitance can be used, but the maximum output voltage may be reduced.

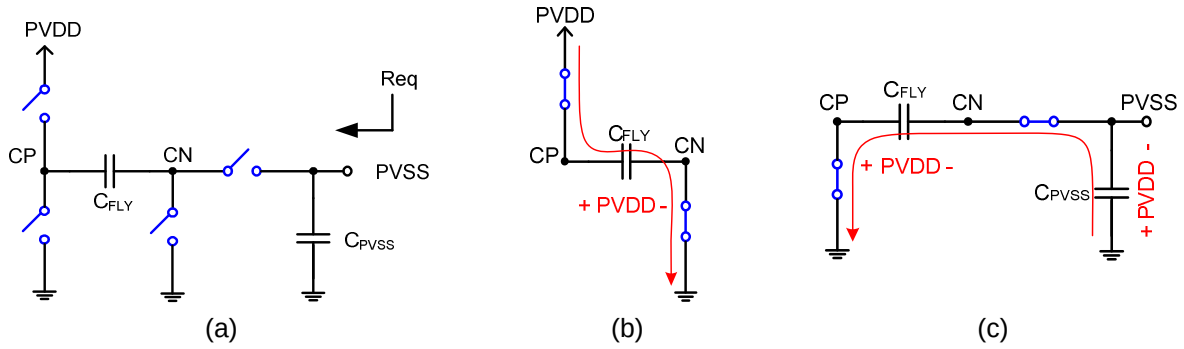


Figure 4. Charge-Pump Operation

Mute Function

The mute function is used to reduce power consumption while the device is not in use. When a logic low is applied to this pin, the output driver circuits are turned off. Line driver output and PVSS are pulled to ground. When a logic high is applied to mute pin, the PVSS is started to build-up and line driver output signal is released after about 0.5ms typically.

Decoupling Capacitors

A low ESR power supply decoupling capacitor is required for better performance. The capacitor should place as close to chip as possible, the value is typically 1μF. For filtering low frequency noise signals, a 10μF or greater capacitor placed near the chip is recommended.

Input Blocking Capacitors (C_{IN})

An input blocking capacitor is required to block the dc voltage of the audio source and allows the input to bias at a proper dc level for optimum operation. The input capacitor and input resistor (R_I) form a high-pass filter with the corner frequency determined as following equation:

$$f_C = \frac{1}{2\pi R_I C_{IN}}$$

Gain Setting Resistors (R_I and R_F)

The line driver's gain is determined by R_I and R_F. The typical configurations of the amplifier are inverting, non-inverting, and differential input, see figure 5. The gain equations are listed as follows:

(a) Inverting configuration : $A_V = -\frac{R_F}{R_I}$

(b) Non-inverting configuration : $A_V = 1 + \frac{R_F}{R_I}$

(c) Differential-input configuration : $A_V = \frac{R_F}{R_I}$

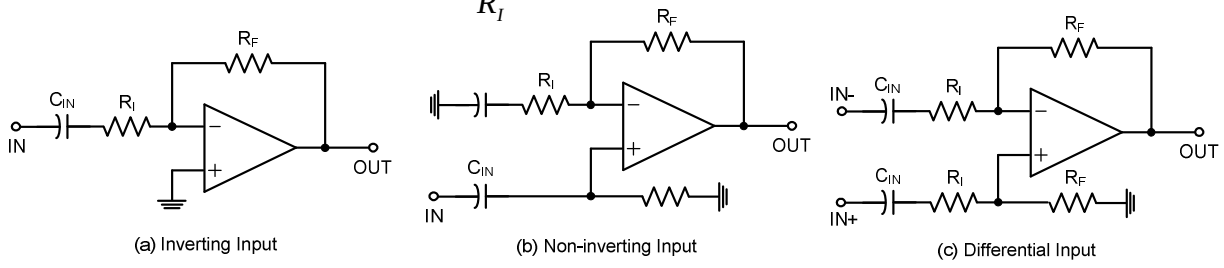


Figure 5. Line Driver Amplifier Configurations

The values of R_I and R_F must be chosen with consideration of stability, frequency response and noise. The recommended value of R_I is in the range from 1kΩ to 47kΩ, and RF is from 4.7kΩ to 100kΩ for. The gain is in the range from -1V/V to -10V/V for inverting configuration. Table 1 lists the recommended resistor values for different configurations.

RI (kΩ)	RF (kΩ)	Inverting Input Gain (V/V)	Non-inverting Input Gain (V/V)	Differential Input Gain (V/V)
22	22	-1	2	1
15	30	-2	3	2
33	68	-2.1	3.1	2.1
10	100	-10	11	10

Table 1. Recommended Resistor Values

Second-Order Filter Configuration

AS9632 can be used like a standard OPAMP. Several filter topologies can be implemented by using AS9632, both single-ended and differential input configuration, see figure 6. For inverting input configuration, the overall gain is $-\frac{R2}{R1}$, the high-pass filter's cutoff frequency is $\frac{1}{2\pi R1C3}$, the low-pass filter's cutoff frequency is $\frac{1}{2\pi\sqrt{R2R3C1C3}}$

The detail component values are listed on table 2.

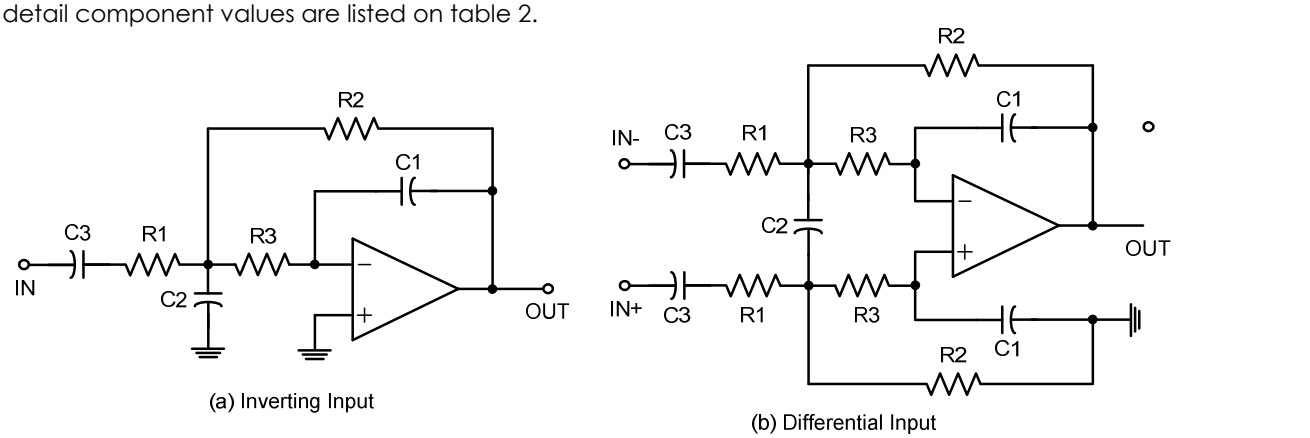


Figure 6. Second-order Active Low-Pass Filter

Gain (V/V)	High Pass (Hz)	Low Pass (kHz)	C1 (pF)	C2 (pF)	C3 (F)	R1 (kΩ)	R2 (kΩ)	R3 (kΩ)
-1	1.6	40	100	680	10	10	10	24
-1.5	1.3	40	68	680	15	8.2	12	30
-2	1.6	60	33	150	6.8	15	30	47
-2	1.6	30	47	470	6.8	15	30	43
-3.33	1.2	30	33	470	10	13	43	43
-10	1.5	30	22	1000	22	4.7	47	27

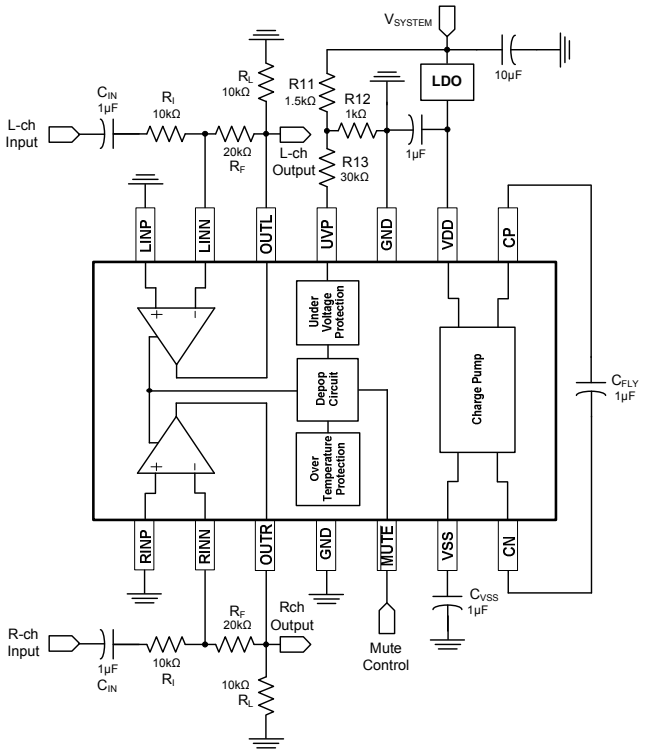
Table 2. Second-order Low-Pass Filter Specifications

Over-Temperature Protection

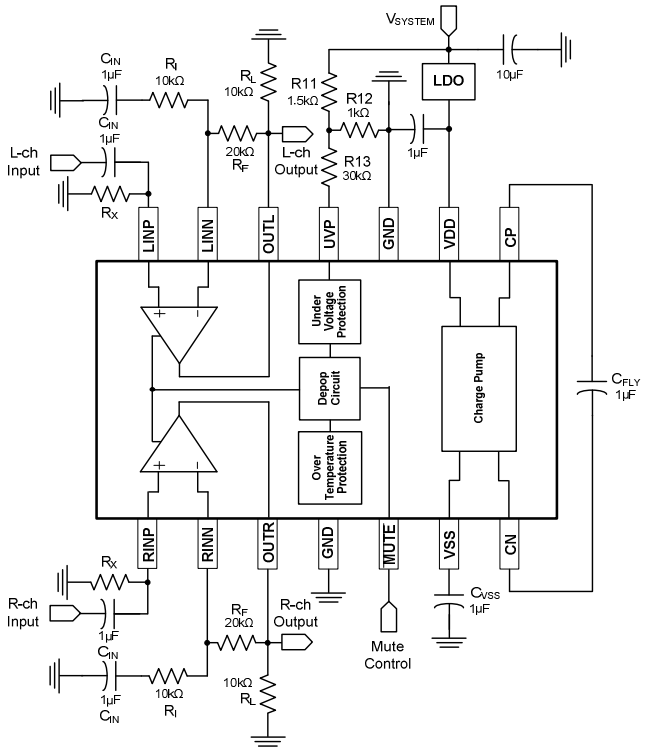
AS9632 provide an over-temperature protection to limit the junction temperature to 150℃. As junction temperature exceeds 150℃, internal thermal sensor will turn off the drivers immediately. The drivers will turn on again if the junction temperature is smaller than 130℃. A 20℃ hysteresis is designed to lower the average junction temperature during continuous thermal overload conditions, increasing lifetime of the chip.

Typical Performance Characteristics

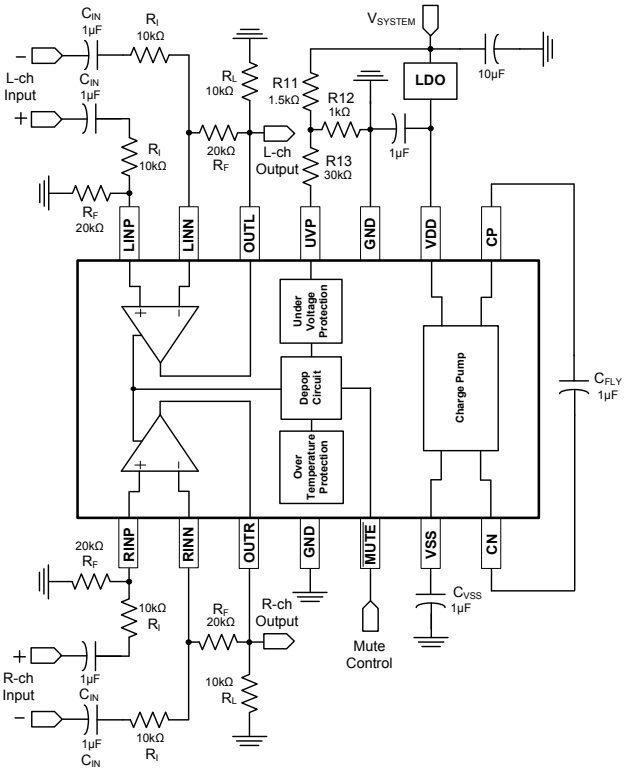
Inverting Input Line Driver Amplifier



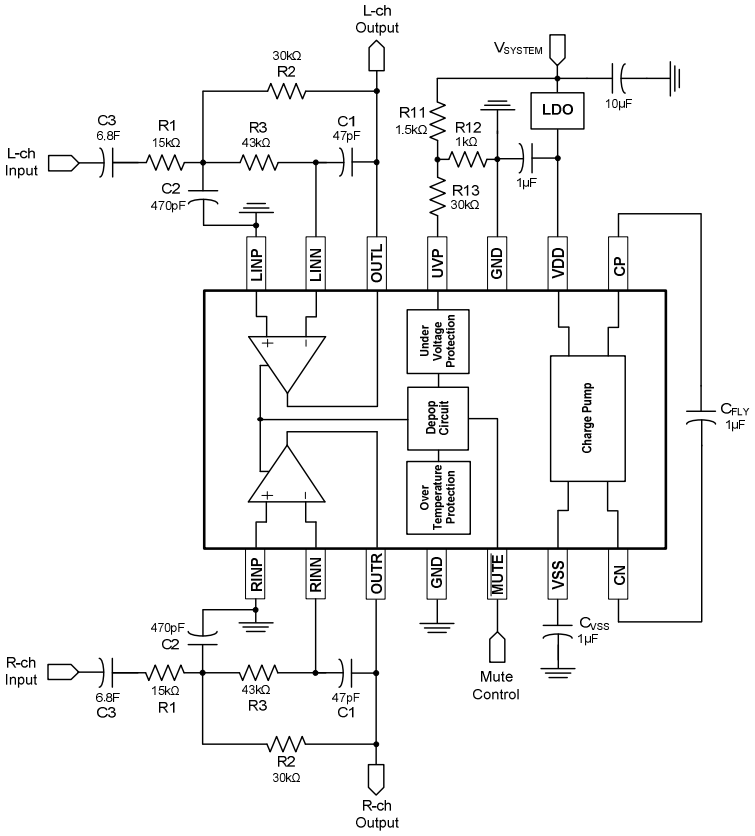
Non-inverting Input Line Driver Amplifier



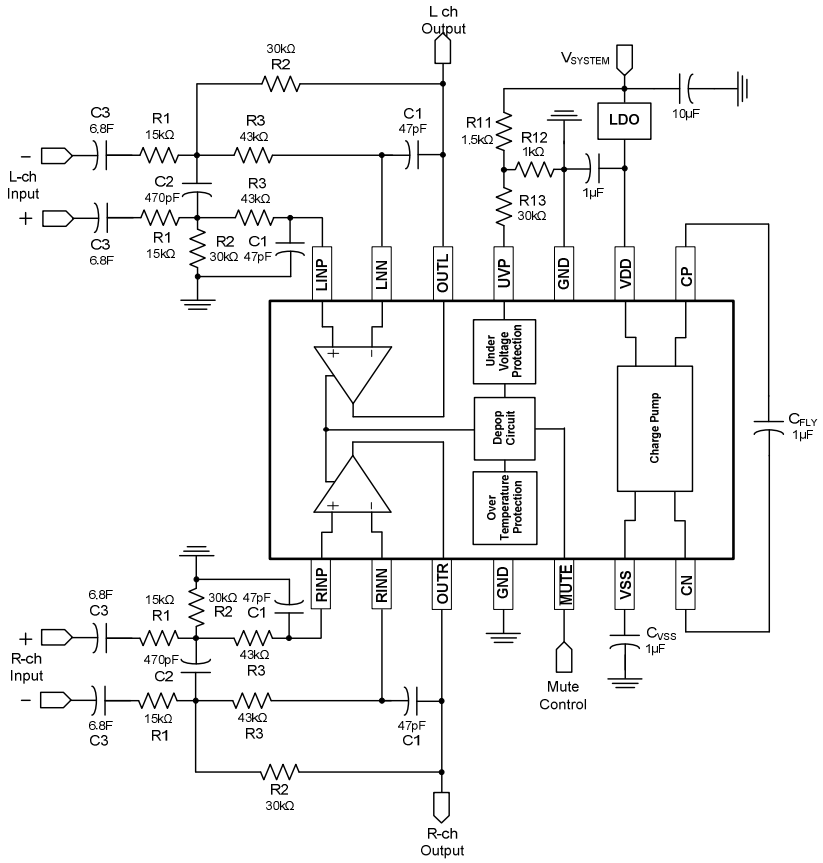
Differential Input Line Driver Amplifier



Inverting Input Second-Order Active Low-Pass Filter

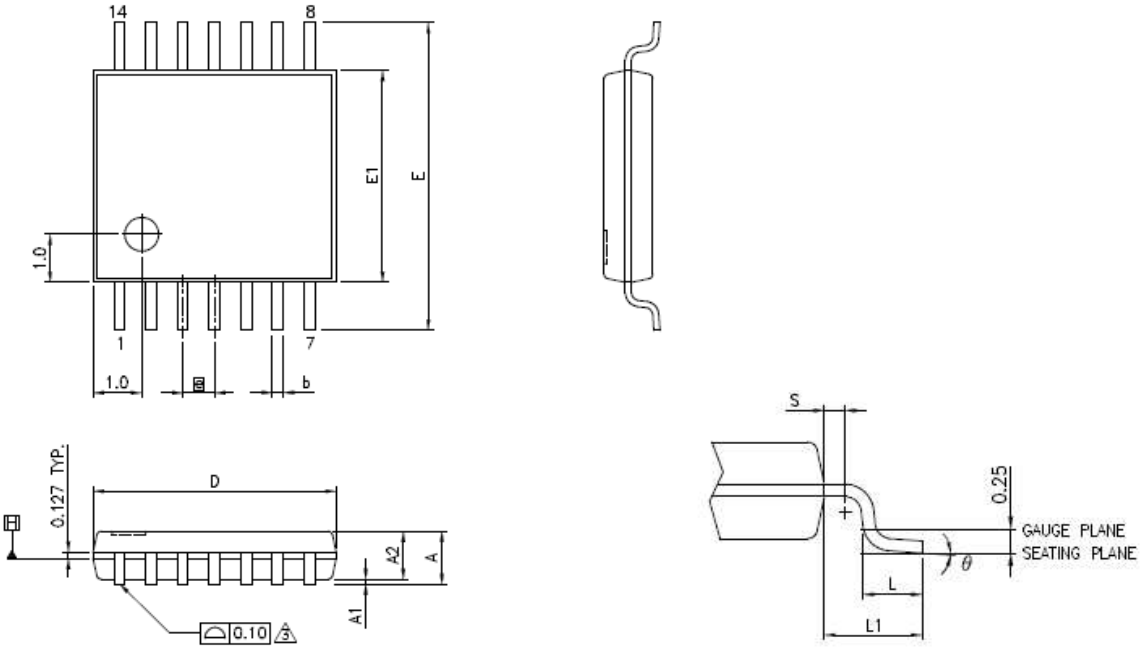


Differential Input Second-Order Active Low-Pass Filter



Package

TSSOP-14



VARIATIONS (ALL DIMENSIONS SHOWN IN MM)

SYMBOLS		MIN.	NOM.	MAX.
A		–	–	1.20
A1	STANDARD	0.05	–	0.15
	THERMALLY ENHANCED	0.00	–	0.15
A2		0.80	1.00	1.05
b		0.19	–	0.30
D		4.90	5.00	5.10
E1		4.30	4.40	4.50
E		6.40 BSC		
e		0.65 BSC		
L1		1.00 REF		
L		0.50	0.60	0.75
S		0.20	–	–
θ		0°	–	8°